

## 1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT78 plastic package intended for use in applications requiring sensitive gate, good bidirectional blocking voltage capability, high surge current capability and high thermal cycling performance.

## 2. Features and benefits

- · Good bidirectional blocking voltage capability
- High surge current capability
- High thermal cycling performance
- Sensitive gate

### 3. Applications

- Ignition circuits
- Motor control
- Protection circuits
- Voltage regulation

### 4. Quick reference data

| Symbol              | Parameter                                | Conditions   | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|------|
| V <sub>DRM</sub>    | repetitive peak off-<br>state voltage    |  | -   | -   | 500 | V    |
| V <sub>RRM</sub>    | repetitive peak reverse voltage          |  | -   | -   | 500 | V    |
| I <sub>TSM</sub>    | non-repetitive peak on-<br>state current | half sine wave; T <sub>j(init)</sub> = 25 °C;<br>t <sub>p</sub> = 10 ms; <u>Fig. 4; Fig. 5</u> | -   | -   | 120 | A    |
|                     |  | half sine wave; T <sub>j(init)</sub> = 25 °C;<br>t <sub>p</sub> = 8.3 ms                       | -   | -   | 132 | A    |
| Tj                  | junction temperature                     |  | -   | -   | 125 | °C   |
| I <sub>T(AV)</sub>  | average on-state current                 | half sine wave; T <sub>mb</sub> ≤ 109 °C; <u>Fig. 1</u>  | -   | -   | 7.5 | A    |
| I <sub>T(RMS)</sub> | RMS on-state current                     | half sine wave; T <sub>mb</sub> ≤ 109 °C; <u>Fig. 2;</u><br><u>Fig. 3</u>                      | -   | -   | 12  | A    |
| Static chara        | acteristics                              | ·  |     |     |     |      |
| I <sub>GT</sub>     | gate trigger current                     | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>           | -   | 2   | 5   | mA   |

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| Symbol              | Parameter                         | Conditions   | Min | Тур  | Max | Unit |
|---------------------|-----------------------------------|--|-----|------|-----|------|
| dV <sub>D</sub> /dt | rate of rise of off-state voltage | $\label{eq:VDM} \begin{array}{l} V_{DM} = 335 \; V; \; T_{j} = 125 \; ^{\circ}\text{C}; \; R_{GK} = 100 \; \Omega; \\ (V_{DM} = 67\% \; of \; V_{DRM}); \; exponential \\ waveform; \; \underline{Fig. \; 12} \end{array}$ | 200 | 1000 | -   | V/µs |

## 5. Pinning information

| Table 2 | . Pinning inf | formation                         |                    |                      |
|---------|---------------|-----------------------------------|--------------------|----------------------|
| Pin     | Symbol        | Description                       | Simplified outline | Graphic symbol       |
| 1       | К             | cathode                           | mb                 | A - <del>D  </del> K |
| 2       | А             | anode                             |                    | Ğ<br>sym037          |
| 3       | G             | gate                              |                    | Symosi               |
| mb      | A             | mounting base; connected to anode |                    |                      |
|         |               |                                   | TO-220AB (SOT78)   |                      |

## 6. Ordering information

#### Table 3. Ordering information

| Type number | Package  |  |         |  |  |
|-------------|----------|--|---------|--|--|
|             | Name     | Description  | Version |  |  |
| BT151-500L  | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78   |  |  |

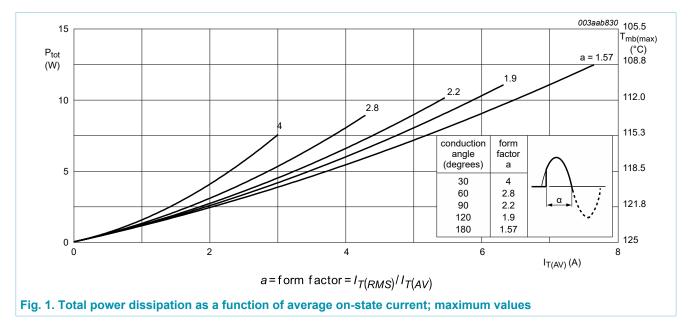
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### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                                | Conditions  | Min | Max | Unit |
|---------------------|--|---|-----|-----|------|
| V <sub>DRM</sub>    | repetitive peak off-state voltage        |   | -   | 500 | V    |
| V <sub>RRM</sub>    | repetitive peak reverse voltage          |   | -   | 500 | V    |
| I <sub>T(AV)</sub>  | average on-state current                 | half sine wave; T <sub>mb</sub> ≤ 109 °C; <u>Fig. 1</u>                 | -   | 7.5 | А    |
| I <sub>T(RMS)</sub> | RMS on-state current                     | half sine wave; $T_{mb} \le 109 \text{ °C}$ ; <u>Fig. 2</u> ;<br>Fig. 3 | -   | 12  | A    |
| I <sub>TSM</sub>    | non-repetitive peak on-<br>state current | half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms;<br>Fig. 4; Fig. 5 | -   | 120 | A    |
|                     |  | half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms                   | -   | 132 | А    |
| l <sup>2</sup> t    | I <sup>2</sup> t for fusing              | t <sub>p</sub> = 10 ms; SIN   | -   | 72  | A²s  |
| dl <sub>T</sub> /dt | rate of rise of on-state current         | I <sub>G</sub> = 10 mA  | -   | 50  | A/µs |
| I <sub>GM</sub>     | peak gate current                        |   | -   | 2   | А    |
| V <sub>RGM</sub>    | peak reverse gate<br>voltage             |   | -   | 5   | V    |
| P <sub>GM</sub>     | peak gate power                          |   | -   | 5   | W    |
| P <sub>G(AV)</sub>  | average gate power                       | over any 20 ms period   | -   | 0.5 | W    |
| T <sub>stg</sub>    | storage temperature                      |   | -40 | 150 | °C   |
| Tj                  | junction temperature                     |   | -   | 125 | °C   |

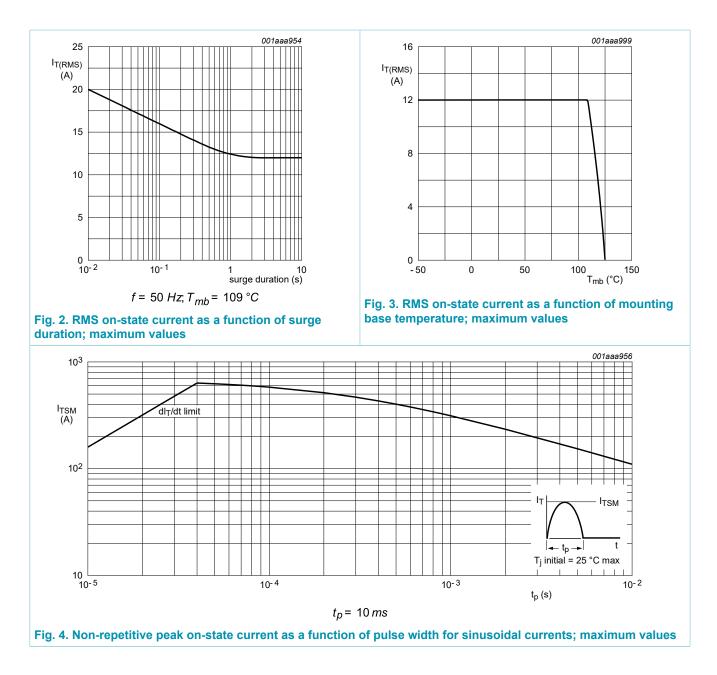


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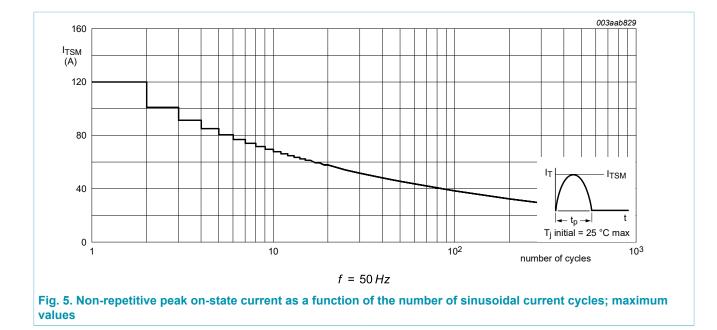


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#### 8. Thermal characteristics

| Symbol                | Parameter  | Conditions    | Min | Тур | Max | Unit |
|-----------------------|--|---------------|-----|-----|-----|------|
| R <sub>th(j-mb)</sub> | thermal resistance<br>from junction to<br>mounting base    | Fig. <u>6</u> | -   | -   | 1.3 | K/W  |
| R <sub>th(j-a)</sub>  | thermal resistance<br>from junction to<br>ambient free air | in free air   | -   | 60  | -   | K/W  |

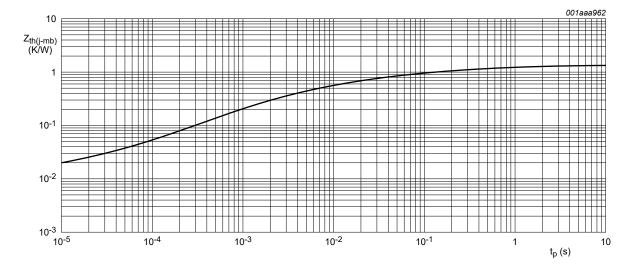


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

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### 9. Characteristics

| Symbol              | Parameter                         | Conditions   | Min       | Тур  | Max  | Unit |
|---------------------|-----------------------------------|--|-----------|------|------|------|
| Static chara        | acteristics                       | · · · ·  |           |      |      |      |
| I <sub>GT</sub>     | gate trigger current              | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>   | -         | 2    | 5    | mA   |
| IL                  | latching current                  | V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>   | -         | 10   | 40   | mA   |
| I <sub>H</sub>      | holding current                   | V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>   | -         | 7    | 20   | mA   |
| V <sub>T</sub>      | on-state voltage                  | I <sub>T</sub> = 23 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>  | -         | 1.4  | 1.75 | V    |
| V <sub>GT</sub>     | gate trigger voltage              | V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C;<br>Fig. 11  | -         | 0.6  | 1.5  | V    |
|                     |                                   | V <sub>D</sub> = 500 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 125 °C;<br>Fig. 11  | 0.25      | 0.4  | -    | V    |
| I <sub>D</sub>      | off-state current                 | V <sub>D</sub> = 500 V; T <sub>j</sub> = 125 °C  | -         | 0.1  | 0.5  | mA   |
| I <sub>R</sub>      | reverse current                   | V <sub>R</sub> = 500 V; T <sub>j</sub> = 125 °C  | -         | 0.1  | 0.5  | mA   |
| Dynamic ch          | aracteristics                     |  | · · · · · |      |      |      |
| dV <sub>D</sub> /dt | rate of rise of off-state voltage | $V_{DM}$ = 335 V; T <sub>j</sub> = 125 °C; R <sub>GK</sub> = 100 Ω;<br>( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential<br>waveform; Fig. 12   | 200       | 1000 | -    | V/µs |
|                     |                                   | $V_{DM}$ = 335 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit; Fig. 12  | 50        | 130  | -    | V/µs |
| t <sub>gt</sub>     | gate-controlled turn-on time      | $I_{TM}$ = 40 A; V <sub>D</sub> = 500 V; I <sub>G</sub> = 0.1 A; dI <sub>G</sub> /<br>dt = 5 A/µs; T <sub>j</sub> = 25 °C  | -         | 2    | -    | μs   |
| t <sub>q</sub>      | commutated turn-off time          | $V_{DM}$ = 335 V; T <sub>j</sub> = 125 °C; I <sub>TM</sub> = 20 A;<br>$V_R$ = 25 V; (dI <sub>T</sub> /dt) <sub>M</sub> = 30 A/µs; dV <sub>D</sub> /<br>dt = 50 V/µs; R <sub>GK(ext)</sub> = 100 Ω; (V <sub>DM</sub> =<br>67% of V <sub>DRM</sub> ) | -         | 70   | -    | μs   |

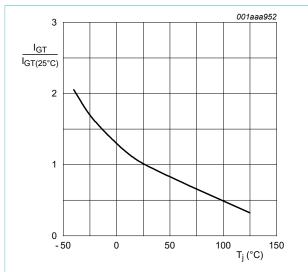
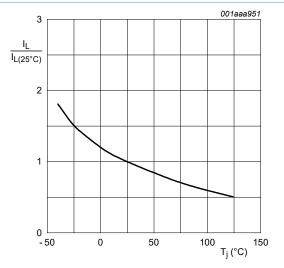


Fig. 7. Normalized gate trigger current as a function of junction temperature

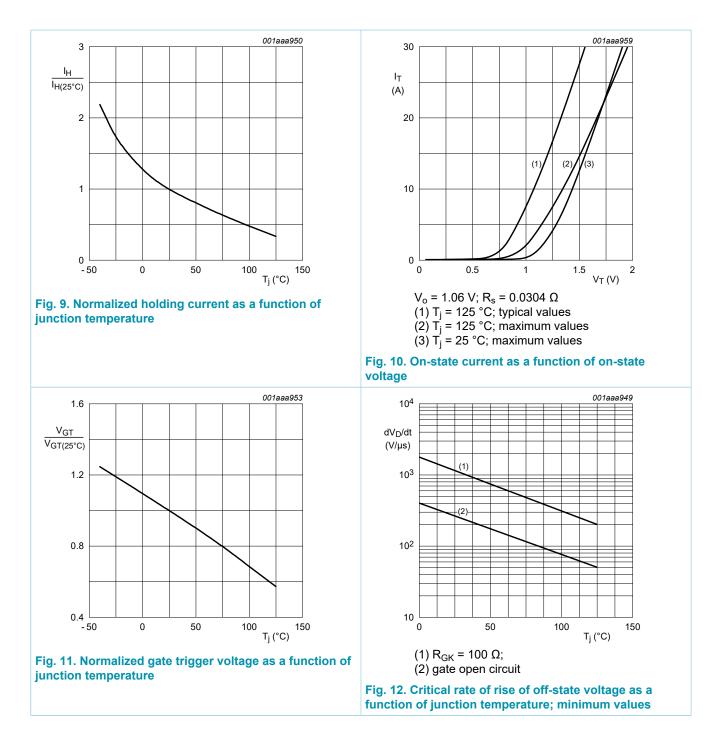




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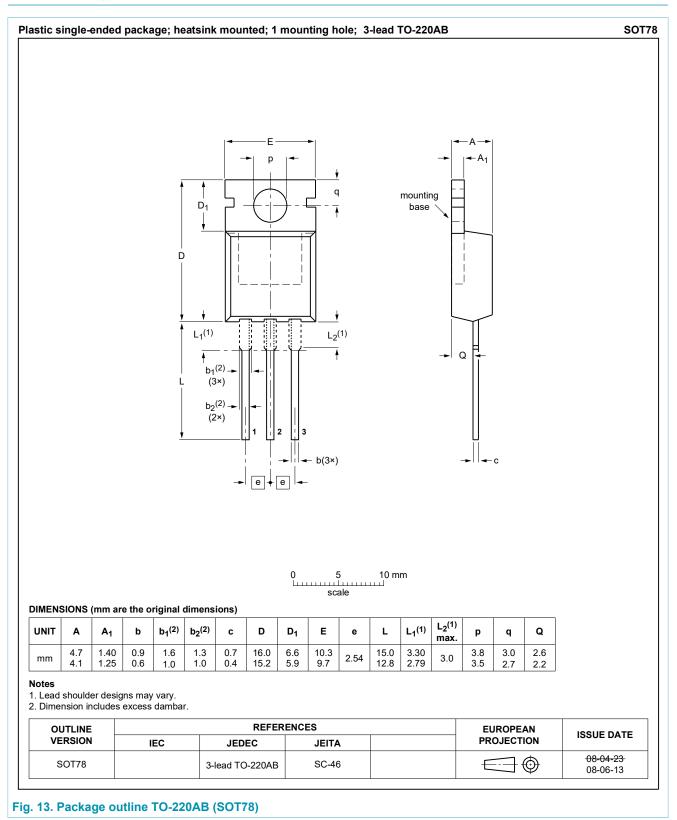


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### **10. Package outline**



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## 11. Legal information

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| Document<br>status [1][2]            | Product<br>status [ <u>3]</u> | Definition  |
|--------------------------------------|-------------------------------|---|
| Objective<br>[short] data<br>sheet   | Development                   | This document contains data from<br>the objective specification for product<br>development. |
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| Product<br>[short] data<br>sheet     | Production                    | This document contains the product specification.   |

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**Product data sheet**